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4-25-02

Micron Docket No.: 01-0263
Docket No.: M4065.0468/P468
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Phillip E. Byrd, et al.

Application No.: 09/041,761

Group Art Unit: 2812

Filed: Concurrently Herewith

Examiner: Not Yet Assigned

For: METHOD AND STRUCTURE FOR
ISOLATING DIE TO FACILITATE WAFER
LEVEL BURN-IN

POWER OF ATTORNEY BY ASSIGNEE AND
CERTIFICATE BY ASSIGNEE UNDER 37 CFR § 3.73(B)

Assistant Commissioner for Patents
Washington, DC 20231

Dear Sir:

Micron Technology, Inc., Assignee of the entire right, title and interest in the above-identified application by virtue of the Assignment attached hereto (which is also being submitted concurrently for recordation), hereby appoints the attorneys and agents of the firm of Dickstein Shapiro Morin & Oshinsky LLP located at 2101 L Street NW, Washington, DC 20037-1526, listed as follows:

Gary M. Hoffman	26,411	Laurence E. Fisher	37,131	Gianni Minutoli	41,198
Thomas J. D'Amico	28,371	John C. Luce	34,378	Michael Bergman	42,318
Donald A. Gregory	28,954	William E. Powell, III	39,803	Mark E. Strickland	45,138
James W. Brady, Jr.	32,115	Patrick T. Skacel	47,948	Salvatore P. Tamburo	45,153
Jon D. Grossman	32,699	Gary L. Veron	39,057	Peter Veytsman	45,920
Mark J. Thronson	33,082	Mialeeka C. Williams-Bibbs	48,037	Christopher S. Chow	46,493
Eric Oliver	35,307	Jeremy A. Cubert	40,399		

and also, listed as follows:

Michael Lynch	30,871	David Paul	34,692	Charles Brantley	38,086
Kevin Martin	37,882	Walter Fields	37,130		

Application No.: Not Yet Assigned

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attorneys of Micron Technology, Inc. as its attorneys with full power of substitution to prosecute this application and to transact all business in the Patent and Trademark Office in connection therewith.

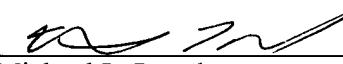
The Assignee certifies that the above-identified assignment has been reviewed and to the best of the Assignee's knowledge and belief, title is in the assignee.

Please direct all correspondence regarding this application to the following:

Thomas J. D'Amico
DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP
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Respectfully submitted,

MICRON TECHNOLOGY, INC.


Michael L. Lynch
Chief Patent Counsel
Registration No. 30,871

Dated: 1/14/2002



Docket No.: M4065.0468/P468

(PATENT)

THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Phillip E. Byrd, et al.

Application No.: 09/941,761

Group Art Unit: 2812

Filed: August 30, 2001

Examiner: Not Yet Assigned

For: METHOD AND STRUCTURE FOR TEMPORARILY
ISOLATING A DIE FROM A COMMON
CONDUCTOR TO FACILITATE WAFER LEVEL
TESTING

**SUBMISSION OF POWER OF ATTORNEY BY ASSIGNEE AND CERTIFICATE
BY ASSIGNEE UNDER 37 CFR §3.73(B)**

Commissioner for Patents
Washington, DC 20231

Dear Sir:

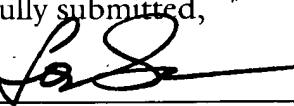
Enclosed for filing in connection with the above-referenced United States Patent Application are the following:

1. Executed Power of Attorney by Assignee and Certificate by Assignee Under 37 CFR §3.73(b); and
2. Copy of executed Assignment and Agreement.

The Commissioner is hereby authorized to charge any fees which may be required to Deposit Account 04-1073.

Dated: January 24, 2002

Respectfully submitted,

By 

Thomas J. D'Amico

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